## 7172

## Low-Current Matrix Card $8 \times 12$



The Model 7172 Low Current Matrix Card is designed specifically for semiconductor research, development, characterization, and reliability applications involving multipoint I-V and C-V measurements. The 7172 is ideal for use with Keithley SMUs, Model 4200, and Models 590 and 595. The configuration for the 7172 is 8 rows by 12 columns with signals and guard switched at each crosspoint. Offset current is specified at $<500 \mathrm{fA}$ ( 150 fA typical) on all signal pathways.

The 7172 switching matrix card contains a built-in offset current self-test circuit that measures the actual performance of the card. A rear panel switch activates the self-test function and pass/fail LEDs on the rear panel indicate if the offset is above or below 500fA. This feature ensures that the 7172 is operating within specified accuracy.
Connections are 3 -lug triax with the outer shell connected to the chassis for safety and noise shielding. The center conductor is fully surrounded by the inner conducting shield so fully guarded measurements can be made with higher isolation and improved speed and accuracy.

## Expansion

- <500fA offset on all signal paths
- 2-pole switching signal and guard
- Expandable to multicard applications
- 200V, 1A signal levels


## Ordering Information

7172 8x12 Low-Current Matrix Card

This product is available with an Extended Warranty.

Accessory Supplied
Instruction manual and eight
SMB expansion cables (C99-1A)


MATRIX CONFIGURATION: Single 8 rows $\times 12$ columns. Expanding the columns can be done internally by connecting the rows of multiple 7172 cards with coax jumpers OFFSET CURRENT SELF TEST: An onboard electrometer circuit measures offset current when the rear panel switch is pushed. Pass/fail LEDs indicate if offset is above or below 500fA. The onboard SMB connector outputs voltage proportional to current ( $1 \mathrm{mV} / 10 \mathrm{fA}$ ).
CROSSPOINT CONFIGURATION: 2-pole Form A (Signal, Guard).
CONNECTOR TYPE: 3-lug triax (Signal, Guard, Chassis).
MAX. SIGNAL LEVEL: Pin-to-pin or pin-to-chassis: 200V. 1A carry/0.5A switched, 10VA. CONTACT LIFE: Cold Switching: $10^{8}$ closures. At Max. Signal Level: $10^{5}$ closures PATH RESISTANCE (Per Conductor): $<1.0 \Omega$ initial, $<1.5 \Omega$ at end of contact life. CONTACT POTENTIAL: Differential (Signal to Guard): $<30 \mu \mathrm{~V}$.

Single ended (Guard to Guard or Signal to Signal): $<60 \mu \mathrm{~V}$. OFFSET CURRENT: <500fA, 150fA typical.
ISOLATION: Path (Signal to Signal): $>10^{13} \Omega, 0.4 \mathrm{pF}$ typical. Differential (Signal to Guard): $>10^{9} \Omega, 170 \mathrm{pF}$ typical. Common (Signal and Guard to Chassis): $>10^{9} \Omega$, 430 pF typical.
CROSSTALK (1MHz, $50 \Omega$ Load): <-70dB
INSERTION LOSS ( $\mathbf{1 M H z}, 50 \Omega$ Load): 0.22 dB typical
3dB BANDWIDTH ( $50 \Omega$ Load, $50 \Omega$ Source): 30 MHz typical.
relay drive current (Per Crosspoint): 30 mA .
RELAY SETTLING TIME: $<2 \mathrm{~ms}$.

### 1.888.KEITHLEY (u.s. only)

